GL100MNxMP Series

■ Features

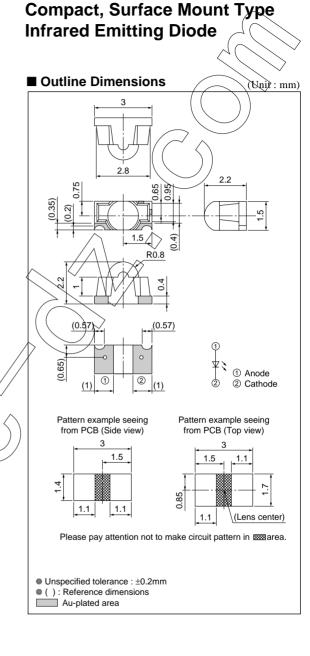
- 1. Compact and thin package
- 2. Surface mount type
- 3. 2-way mounting;top view/side view
- 4. Reflow soldering
- 5. High output type: GL100MN1MP
- General purpose type:GL100MN0MP
 Pair use with PT100MC0MP/PT100MF0MP
 is recommended

■ Applications

- 1. Touch panel for ATM
- 2. Touch panel for Car navigation system
- 3. Touch panel for FA equipment

Absolute Maximum Ratings $(T_a=25^{\circ}C)$						
Parameter	Symbol	Rating	Unit			
Forward current	I_{F}	50	mA			
*1 Peak forward current	I_{FM}	0.5	A			
Reverse voltage	V _R	6	V			
Power dissipation	P	75	mW <			
Operating temperature	Topr	-30 to +85	°C>>			
Storage temperature	T _{stg}	-40 to +95	\%C^			
*2 Soldering temperature	Tsol	240	\\(\frac{1}{C}\)			

^{*1} Pulse width 100µs, duty 0.01



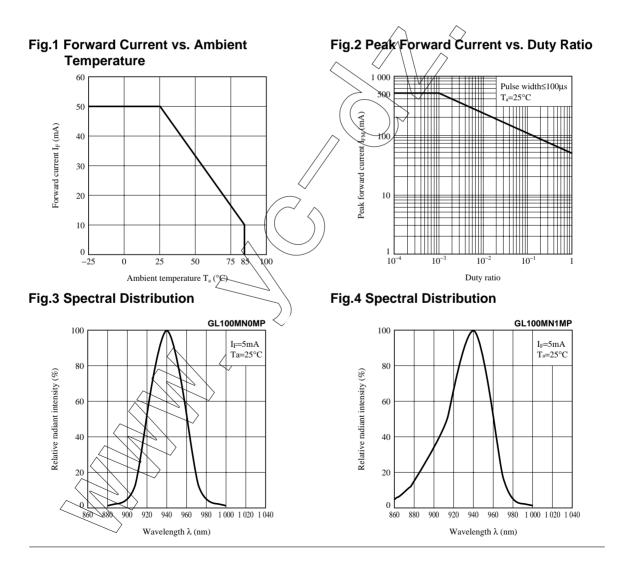
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Internet address for Electronic Components Group http://sharp-world.com/ecg/

^{*2} Max. 10s

■ Electro-optical Characteristi	ics
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■ Electro-optical Characteristics $(T_a=25^{\circ}C)$										
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit			
Forward voltage	GL100MN0MP	V_{F}	$I_F=20mA$	_	1.2	1.4(X			
	GL100MN1MP	$V_{\rm F}$	$I_F=20mA$	_	1.2	1.5	V			
Peak forward voltage		V _{FM}	$I_{FM}=0.5A$	_	3.0	4.0	À			
Reverse current		I_R	$V_R=3V$	_	-/	10	μĂ			
Radiant flux	GL100MN0MP	$\Phi_{ m e}$	$I_F=20mA$	1.0	1	3.0	√ mW			
	GL100MN1MP	Φ_{e}	$I_F=20mA$	2.0	1 +	6.0	mW			
Peak emission wavelength		$\lambda_{ m p}$	$I_F=5mA$	_	940	u	nm			
Half intensity wave length		Δλ	$I_F=5mA$	<i>f</i>	45		nm			
Terminal capacitance		C_t	$V_R=0$, $f=1MHz$	I (-(50	_	pF			
Response frequency		f_c		1-1	3Ø0/	_	kHz			
Half intensity angle		Δθ			±1/0	_	0			



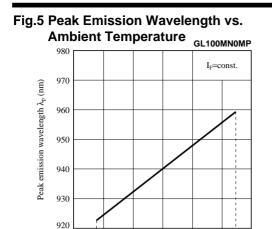


Fig.6 Peak Emission Wavelength vs.
Ambient Temperature

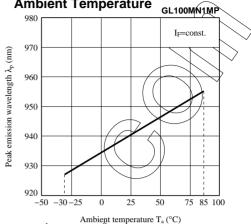
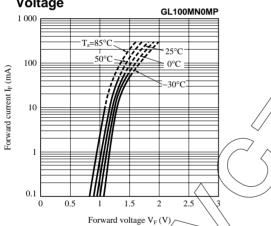


Fig.7 Forward Current vs. Forward Voltage

-50 -30 -25



Ambient temperature Ta (°C)

75 85 100

Fig.8 Forward Current vs. Forward

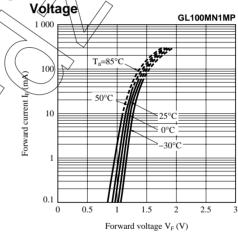


Fig.9 Relative Radiant Flux vs. Ambient
Temperature

GL100MN0MP

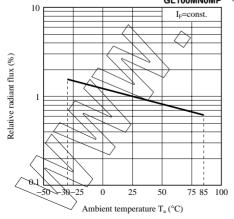


Fig.10 Relative Radiant Flux vs. Ambient Temperature

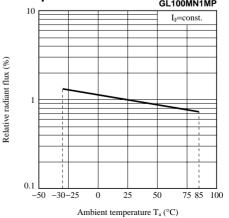


Fig.11 Radiant Flux vs. Forward

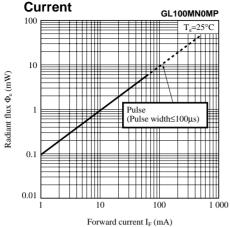


Fig.13 Relative Output vs. Distance To Detector

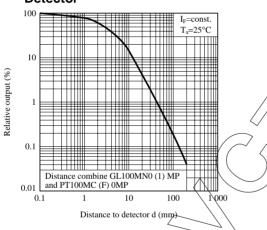


Fig.15 Reflow Soldering

Only one time soldering is recommended within the temperature profile shown below.

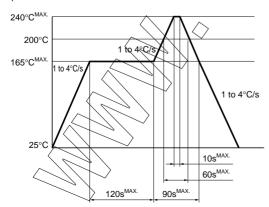


Fig.12 Radiant Flux vs. Forward

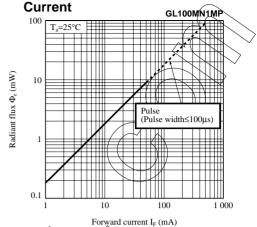
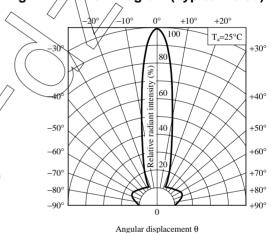


Fig.14 Radiation Diagram (Typical Value)



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 - --- Office automation equipment
 - --- Telecommunication equipment [terminal]
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